



Connectors > Socket Connectors > IC Sockets > LGA Sockets > LGA 3647 Sockets



IC Socket Type: **LGA 3647**

Number of Positions: **3647**

Contact Mating Area Plating Material Thickness: **[30 µin]**

Centerline (Pitch): **.86 mm, .99 mm [.034 in, .039 in]**

Termination Method to PCB: **Surface Mount - Solder Ball**

[All LGA 3647 Sockets \(0\)](#)

Features

Product Type Features

Connector System	Board-to-Board
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Number of Positions	3647
Grid Spacing	.9906 x .8585 mm[.039 x .0338 in]

Body Features

Frame Style	Square
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Contact Features

Contact Mating Area Plating Material	Gold
Contact Base Material	Copper Alloy
IC Socket Type	LGA 3647
	30 µin
Contact Current Rating (Max)	.5 A

Termination Features

Termination Method to PCB	Surface Mount - Solder Ball
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Mechanical Attachment



Connector Mounting Type	Board Mount
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Housing Features

Housing Material	High Temperature Thermoplastic
Housing Color	Black
Centerline (Pitch)	.86 mm, .99 mm[.034 in][.039 in]

Usage Conditions

Operating Temperature Range	-25 – 100 °C[-13 – 212 °F]
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Operation/Application

Circuit Application	Signal
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Industry Standards

UL Flammability Rating	UL 94V-0
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Packaging Features

Packaging Method	Tray
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Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on



requirements for substances in articles’ posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts

TE Part # CAT-D3304-SO1399
DDR4 DIMM SOCKETS

TE Part # CAT-L59017-A76H
LGA 3647 Socket Hardware

TE Part # 5-2199154-4
DDR4 DIMM 288 PIN TH TYPE

TE Part # 5-2199154-5
DDR4 DIMM 288 PIN TH TYPE

TE Part # 2299806-1
NRW NON-FABRIC CARRIER,
SOCKET P0

TE Part # 2305234-1
SOCKET P HARDWARE DUST COVER

TE Part # 2310927-1
CARRIER, NARROW FABRIC, SOCKET
P

TE Part # 2821722-2
IFP/LEC CBL ASSY 1 PORT TYPE B
STR INV

TE Part # 2821722-3
IFP/LEC CBL ASSY 1 PORT TYPE B
STR INV

TE Part # 2821722-4
IFP/LEC CBL ASSY 1 PORT TYPE B
STR INV

Customers Also Bought

TE Part #1-5499922-0
A/L UNIV HDR 50P VERT LG LAT

TE Part #5352171-1
Z-PACK/B19 RAF 95P

TE Part #1367629-2
cage assy, 20 press fit, sfp w

TE Part #5555140-1
MJ,LPF,R/A,6P/6C,SHLD,PNL GRD





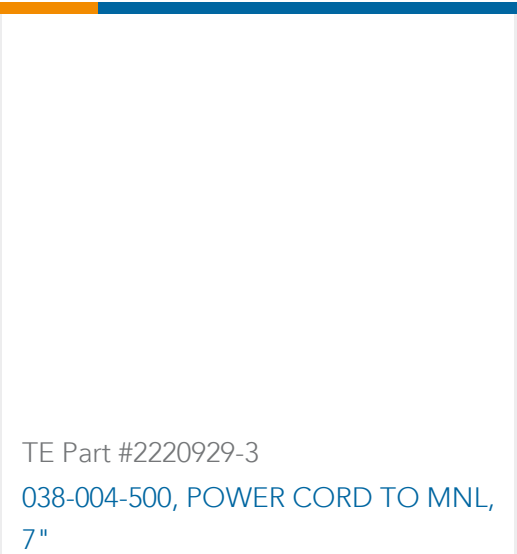
TE Part #1734366-2
Std USB Type A, VT, T/H, White



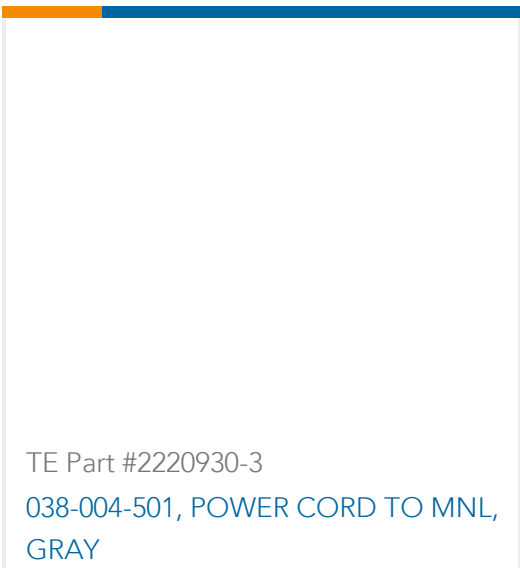
TE Part #2013290-1
SEMI-HARD TRAY DDR3 204P 5.2H RVS



TE Part #214550-E
MSPPM 5 M SMD M2 * A V 137 094 * E008 J



TE Part #2220929-3
038-004-500, POWER CORD TO MNL, 7"



TE Part #2220930-3
038-004-501, POWER CORD TO MNL, GRAY

Documents

Product Drawings

LGA3647-0 SOCKET P0 KIT FOR ODM (30U AU)

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2-2822979-3_C.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2-2822979-3_C.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2-2822979-3_C.3d_stp.zip

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Datasheets & Catalog Pages

LGA 3647 Socket Product Flyer

English

Product Specifications

Application Specification

English